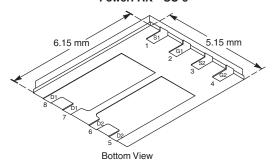


Vishay Siliconix

Dual P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
- 30	0.0055 at $V_{GS} = -10 \text{ V}$	- 60	51 nC			
	0.0078 at $V_{GS} = -4.5 \text{ V}$	- 60	51110			

PowerPAK® SO-8



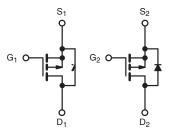
Ordering Information: Si7997DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- **PWM Optimized**
- 100 % R_g Tested 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



RoHS COMPLIANT HALOGEN **FREE**



P-Channel MOSFET P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		- 60 ^a		
Ocation - During Ocase / T. 450 (O)	T _C = 70 °C	1 .	- 60 ^a		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D	- 20.8 ^{b, c}		
	T _A = 70 °C		- 16.6 ^{b, c}		
Pulsed Drain Current		I _{DM}	- 100	Α	
Continuous Course Dusin Diada Current	T _C = 25 °C		- 38		
Continuous Source-Drain Diode Current	T _A = 25 °C	- I _S	- 2.9 ^{b, c}		
Single Pulse Avalanche Current	1 01 mll	I _{AS}	- 30		
Single Pulse Avalanche Energy L = 0.1 mF		E _{AS}	45	mJ	
	T _C = 25 °C		46		
Mariana Paran Disaination	T _C = 70 °C		29	147	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.5 ^{b, c}	W	
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	90	
Soldering Recommendations (Peak Tempera	1	260	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	26	35	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	2.2	2.7		

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See solder profile (www.vishay.com/ppq?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 85 °C/W.

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		- 23		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = -250 \mu A$		5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 1.0		- 2.2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 1		
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 20			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V, I _D = - 20 A		0.0045	0.0055	Ω	
	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -20 \text{ A}$		0.0063	0.0078		
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 20 A		71		S	
Dynamic ^b				_			
Input Capacitance	C _{iss}			6200		pF	
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		615			
Reverse Transfer Capacitance	C _{rss}			560			
Total Oaks Observe	Qg	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -20 \text{ A}$		106	160	nC	
Total Gate Charge				51	77		
Gate-Source Charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -20 \text{ A}$		17			
Gate-Drain Charge	Q_{gd}			16.5			
Gate Resistance	R_{g}	f = 1 MHz	0.9	4.6	9.2	Ω	
Turn-On Delay Time	t _{d(on)}			60	90		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		50	75	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		80	120		
Fall Time	t _f			40	60		
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		10	15		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 10 A, V_GEN = - 10 V, R_g = 1 Ω		115	175		
Fall Time	t _f			40	60		
Drain-Source Body Diode Characteristic	s			•	•		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 38	^	
Pulse Diode Forward Current ^a	I _{SM}				- 100	A	
Body Diode Voltage	V _{SD}	I _S = - 10 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			35	55	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 10 A dl/dt = 100 A/v = T = 05 °C		30	45	nC	
Reverse Recovery Fall Time	t _a	$I_F = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		15			
Reverse Recovery Rise Time	t _b			20		ns	

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

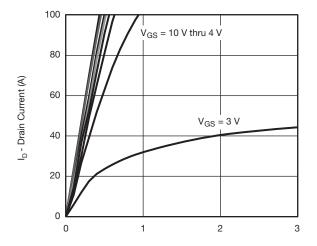
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

20

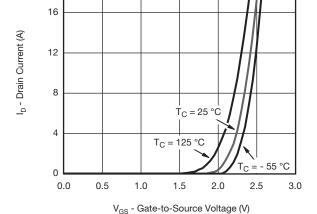


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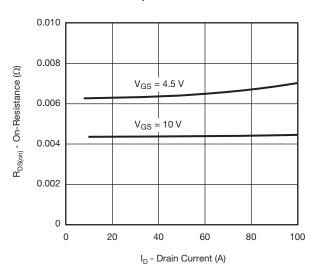
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



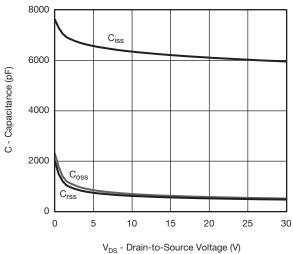
V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics**



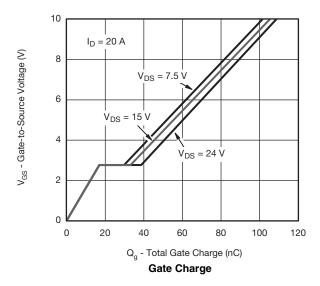
Transfer Characteristics

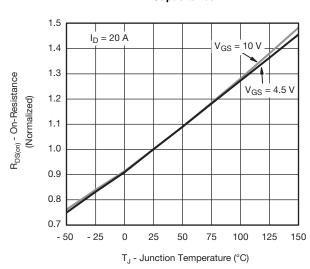


On-Resistance vs. Drain Current and Gate Voltage



Capacitance



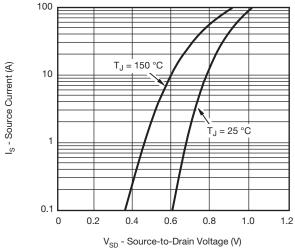


On-Resistance vs. Junction Temperature

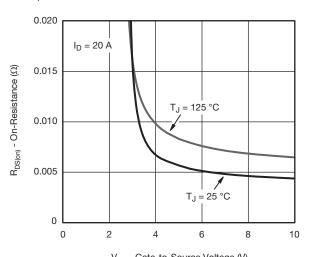
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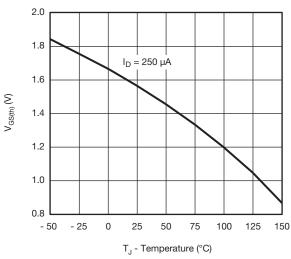
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

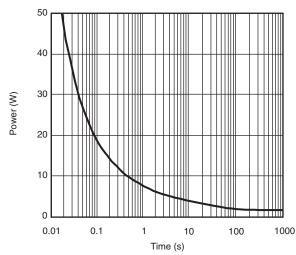


Source-Drain Diode Forward Voltage

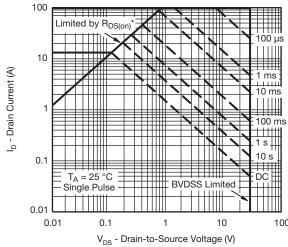




Threshold Voltage



Single Pulse Power



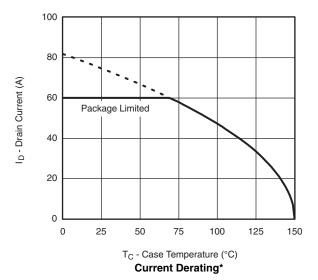
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

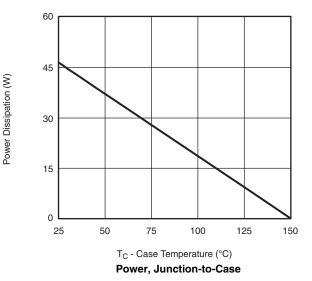
Safe Operating Area



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





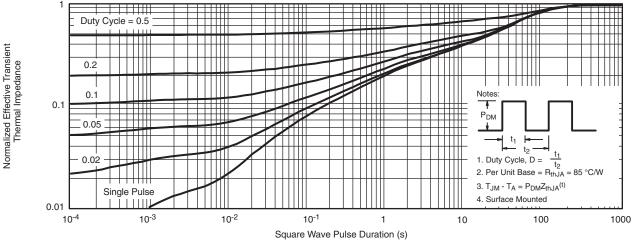
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^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

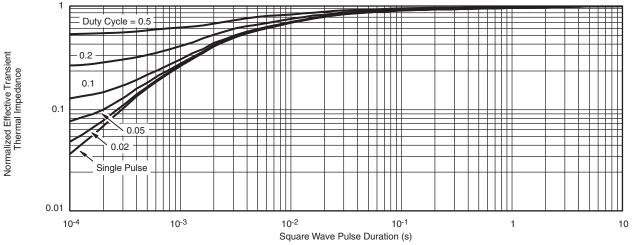
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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